



# 1 Schematic diagram

Figure 1. Schematic diagram

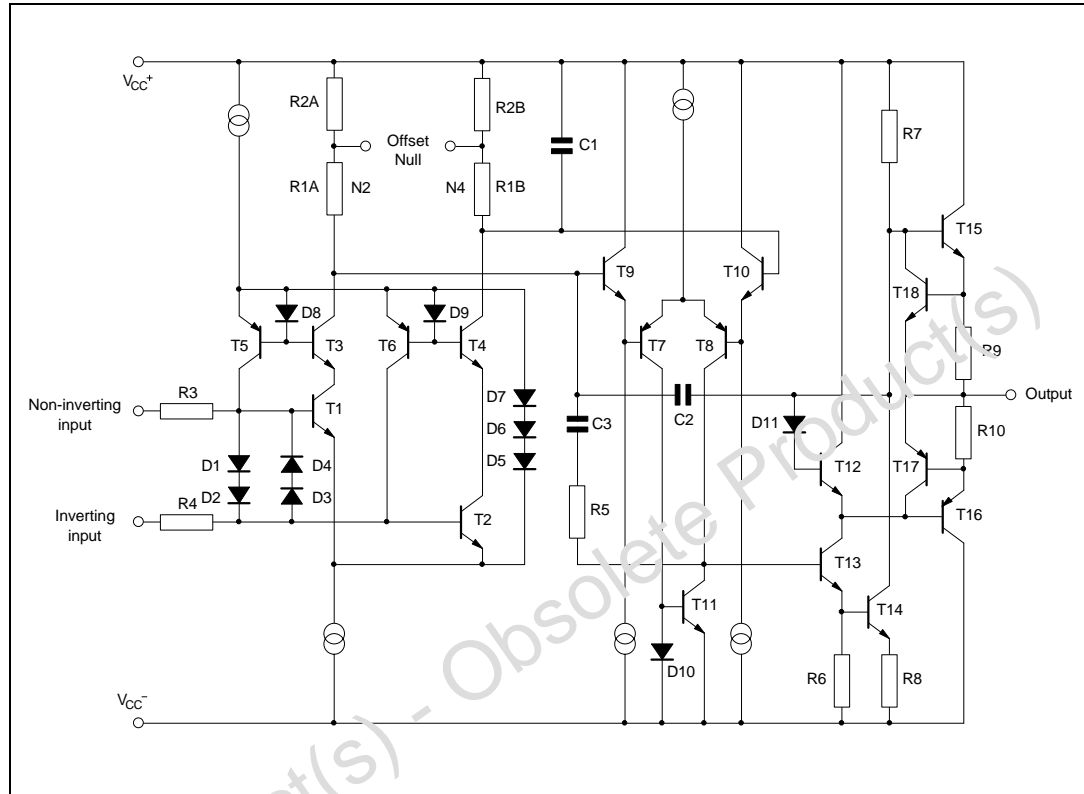
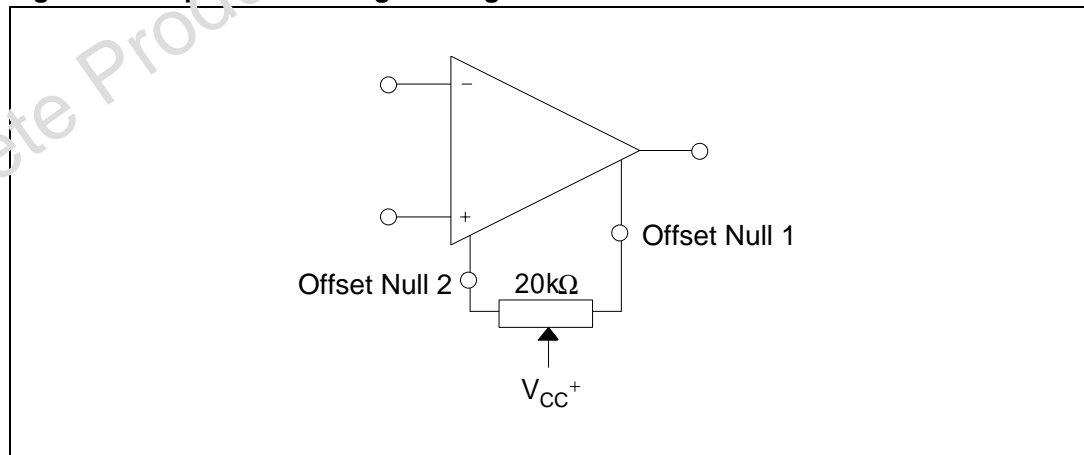


Figure 2. Input of set voltage nulling circuit



## 2 Absolute maximum ratings

**Table 1. Absolute maximum ratings**

Symbol	Parameter	Value	Unit
$V_{CC}$	Supply voltage	$\pm 22$	V
$V_{id}$	Differential input voltage	$\pm 30$	V
$V_i$	Input voltage	$\pm 22$	V
$T_{oper}$	Operating temperature	-40 to 105	°C
$T_{stg}$	Storage temperature	-65 to 150	°C
$R_{thja}$	Thermal resistance junction to ambient <sup>(1) (2)</sup> DIP8	85	°C/W
$R_{thjc}$	Thermal resistance junction to case <sup>(1) (2)</sup> DIP8	4	°C/W
ESD	HBM: human body model <sup>(3)</sup>	1.5	kV
	MM: machine model <sup>(4)</sup>	200	V
	CDM: charged device model <sup>(5)</sup>	1.5	kV

1. Short-circuits can cause excessive heating and destructive dissipation.
2.  $R_{th}$  are typical values.
3. Human body model: 100pF discharged through a 1.5k $\Omega$  resistor between two pins of the device, done for all couples of pin combinations with other pins floating.
4. Machine model: a 200pF cap is charged to the specified voltage, then discharged directly between two pins of the device with no external series resistor (internal resistor < 5 $\Omega$ ). Done for all couples of pin combinations with other pins floating.
5. Charged device model: all pins plus package are charged together to the specified voltage and then discharged directly to the ground.

### 3 Electrical characteristics

Table 2.  $V_{CC^+} = 15\text{ V}$ ,  $V_{CC^-} = \text{Ground}$ ,  $T_{\text{amb}} = 25^\circ\text{ C}$  (unless otherwise specified)

Symbol	Parameter	Min.	Typ.	Max.	Unit
$V_{io}$	Input offset voltage $0^\circ\text{C} \leq T_{\text{amb}} \leq +105^\circ\text{C}$		60	150 250	$\mu\text{V}$
	Long term input offset - voltage stability <sup>(1)</sup>		0.4	2	$\mu\text{V}/\text{Mo}$
$DV_{io}$	Input offset voltage drift		0.5	1.8	$\mu\text{V}/^\circ\text{C}$
$I_{io}$	Input offset current ( $V_{ic} = 0\text{V}$ ) $0^\circ\text{C} \leq T_{\text{amb}} \leq +105^\circ\text{C}$		0.8	6 7	nA
$DI_{io}$	Input offset current drift		15	50	$\text{pA}/^\circ\text{C}$
$DI_{ib}$	Input bias current drift		15	50	$\text{pA}/^\circ\text{C}$
$R_o$	Open loop output resistance		50		$\Omega$
$R_{id}$	Differential input resistance		33		M $\Omega$
$R_{ic}$	Common mode input resistance		120		G $\Omega$
$V_{icm}$	Input common mode voltage range $0^\circ\text{C} \leq T_{\text{amb}} \leq +105^\circ\text{C}$	$\pm 13$ $\pm 13$	$\pm 13.5$		V
CMR	Common-mode rejection ratio ( $V_{ic} = V_{icm - min}$ ) $0^\circ\text{C} \leq T_{\text{amb}} \leq +105^\circ\text{C}$	100 97	120		dB
SVR	Supply voltage rejection ratio ( $V_{CC} = \pm 3$ to $\pm 18\text{V}$ ) $0^\circ\text{C} \leq T_{\text{amb}} \leq +105^\circ\text{C}$	90 86	104		dB
$A_{vd}$	Large signal voltage gain $V_{CC} = \pm 15$ , $R_L = 2\text{k}\Omega$ , $V_o = \pm 10\text{V}$ $0^\circ\text{C} \leq T_{\text{amb}} \leq +105^\circ\text{C}$ $V_{CC} = \pm 3$ , $R_L = 500\Omega$ , $V_o = \pm 0.5\text{V}$	120 100 100	400		V/mV
$V_{opp}$	Output voltage swing $R_L = 10\text{k}\Omega$ $R_L = 2\text{k}\Omega$ $R_L = 1\text{k}\Omega$ $0^\circ\text{C} \leq T_{\text{amb}} \leq +105^\circ\text{C}$ $R_L = 2\text{k}\Omega$	$\pm 12$ $\pm 11.5$  $\pm 11$	$\pm 13$ $\pm 12.8$ $\pm 12$		V
SR	Slew rate ( $R_L = 2\text{k}\Omega$ , $C_L = 100\text{pF}$ )		0.17		V/ $\mu\text{s}$
GBP	Gain bandwidth product ( $R_L = 2\text{k}\Omega$ , $C_L = 100\text{pF}$ , $f = 100\text{kHz}$ )		0.5		MHz
$I_{CC}$	Supply current - no load $0^\circ\text{C} \leq T_{\text{amb}} \leq +105^\circ\text{C}$ $V_{CC} = \pm 3\text{V}$		2.7 0.67	5 6 1.3	mA

Table 2.  $V_{CC^+} = 15\text{ V}$ ,  $V_{CC^-} = \text{Ground}$ ,  $T_{\text{amb}} = 25^\circ\text{ C}$  (unless otherwise specified) (continued)

Symbol	Parameter	Min.	Typ.	Max.	Unit
$e_n$	Equivalent input noise voltage f = 10Hz f = 100Hz f = 1kHz		11 10.5 10	20 13.5 11.5	$\frac{\text{nV}}{\sqrt{\text{Hz}}}$
$i_n$	Equivalent input noise current f = 10Hz f = 100Hz f = 1kHz		0.3 0.2 0.1	0.9 0.3 0.2	$\frac{\text{pA}}{\sqrt{\text{Hz}}}$

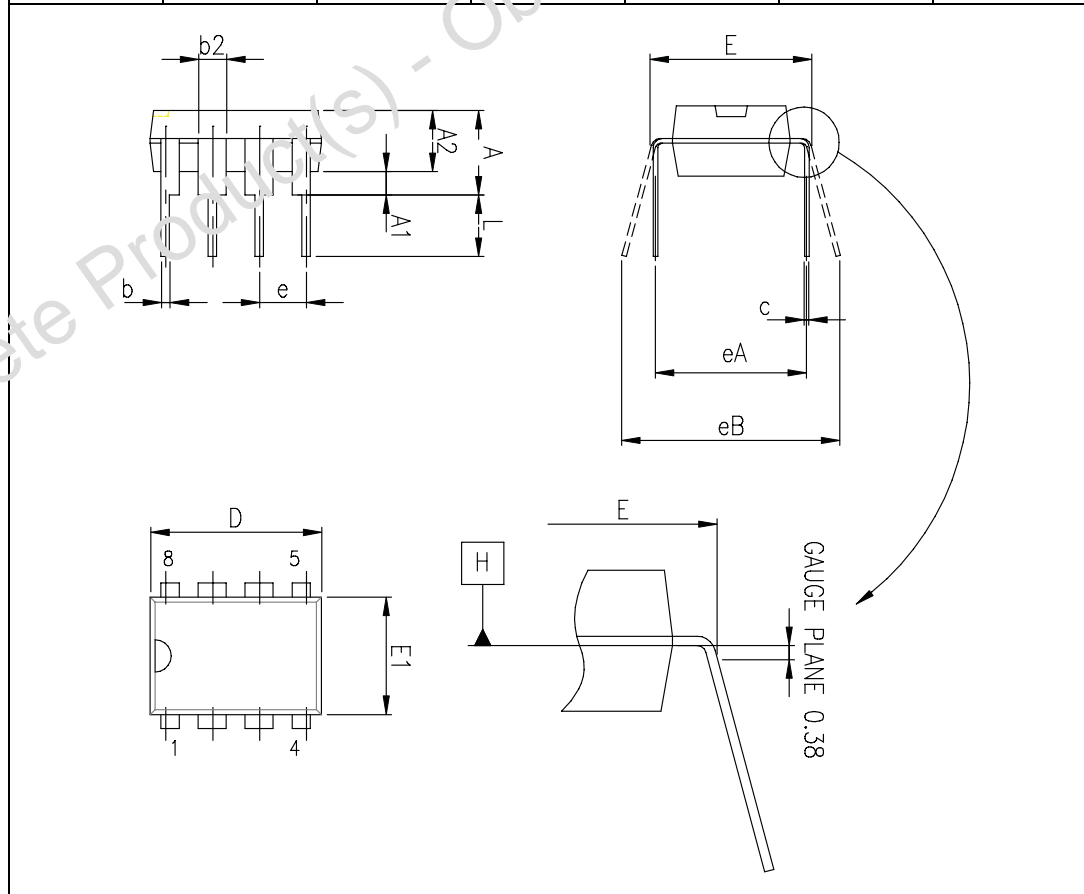
1. Long term input offset voltage stability refers to the average trend line of  $V_{io}$  vs time over extended periods after the first 30 days of operation.

## 4 Package information

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at [www.st.com](http://www.st.com).

Figure 3. DIP8 package mechanical data

Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A			5.33			0.210
A1	0.38			0.015		
A2	2.92	3.30	4.95	0.115	0.130	0.195
b	0.36	0.46	0.56	0.014	0.018	0.022
b2	1.14	1.52	1.78	0.045	0.060	0.070
c	0.20	0.25	0.36	0.008	0.010	0.014
D	9.02	9.27	10.16	0.355	0.365	0.400
E	7.62	7.87	8.26	0.300	0.310	0.325
E1	6.10	6.35	7.11	0.240	0.250	0.280
e		2.54			0.100	
eA		7.62			0.300	
eB			10.92			0.430
L	2.92	3.30	3.81	0.115	0.130	0.150



## 5 Ordering information

Table 3. Order codes

Part number	Temperature range	Package	Packing	Marking
OP07C OP07CN	0°C, +105°C	DIP8	Tube	OP07CN

## 6 Revision history

Table 4. Document revision history

Date	Revision	Changes
20-May-2003	1	Initial release.
23-Jul-2007	2	Format update. R <sub>thja</sub> , R <sub>thjc</sub> , and ESD values added in <a href="#">Table 1: Absolute maximum ratings</a> . Temperature range modified to 0-105°C.

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